

# DATA SHEET

**74LV14**

Hex inverting Schmitt-trigger

Product specification  
Supersedes data of 1997 Feb 03  
IC24 Data Handbook

1998 Apr 20

## Hex inverting Schmitt-trigger

74LV14

## FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for Low Voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between  $V_{CC} = 2.7$  V and  $V_{CC} = 3.6$  V
- Typical  $V_{OLP}$  (output ground bounce)  $< 0.8$  V at  $V_{CC} = 3.3$  V,  $T_{amb} = 25^{\circ}\text{C}$ .
- Typical  $V_{OHV}$  (output  $V_{OH}$  undershoot)  $> 2$  V at  $V_{CC} = 3.3$  V,  $T_{amb} = 25^{\circ}\text{C}$ .
- Output capability: standard
- $I_{CC}$  category: SSI

## APPLICATIONS

- Wave and pulse shapers for highly noisy environments

## DESCRIPTION

The 74LV14 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT14.

The 74LV14 provides six inverting buffers with Schmitt-trigger action. It is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

## QUICK REFERENCE DATA

GND = 0 V;  $T_{amb} = 25^{\circ}\text{C}$ ;  $t_r = t_f \leq 2.5$  ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
$t_{PHL}/t_{PLH}$	Propagation delay nA to nY	$C_L = 15$ pF; $V_{CC} = 3.3$ V	13	ns
$C_I$	Input capacitance		3.5	pF
$C_{PD}$	Power dissipation capacitance per gate	See Notes 1 and 2	15	pF

## NOTES:

- $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ )  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  $C_L$  = output load capacitance in pF;  
 $f_o$  = output frequency in MHz;  $V_{CC}$  = supply voltage in V;  
 $\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.
- The condition is  $V_I = \text{GND to } V_{CC}$ .

## ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	$-40^{\circ}\text{C to } +125^{\circ}\text{C}$	74LV14 N	74LV14 N	SOT27-1
14-Pin Plastic SO	$-40^{\circ}\text{C to } +125^{\circ}\text{C}$	74LV14 D	74LV14 D	SOT108-1
14-Pin Plastic SSOP Type II	$-40^{\circ}\text{C to } +125^{\circ}\text{C}$	74LV14 DB	74LV14 DB	SOT337-1
14-Pin Plastic TSSOP Type I	$-40^{\circ}\text{C to } +125^{\circ}\text{C}$	74LV14 PW	74LV14PW DH	SOT402-1

## PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 5, 9, 11, 13	1A – 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y – 6Y	Data outputs
7	GND	Ground (0 V)
14	$V_{CC}$	Positive supply voltage

## FUNCTION TABLE

INPUT	OUTPUT
nA	nY
L	H
H	L

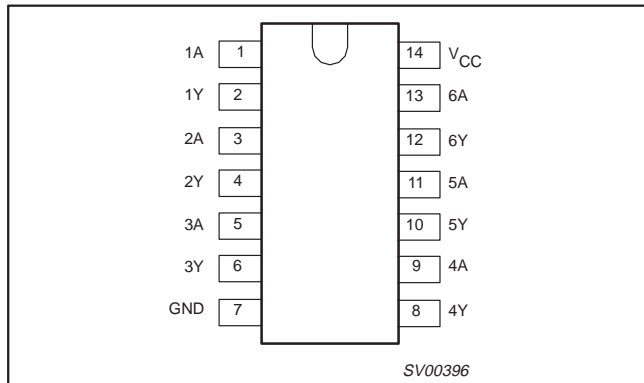
## NOTES:

H = HIGH voltage level  
L = LOW voltage level

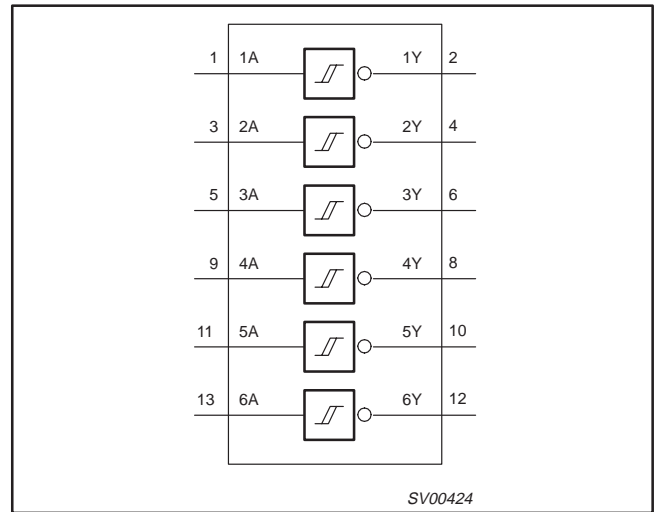
# Hex inverting Schmitt-trigger

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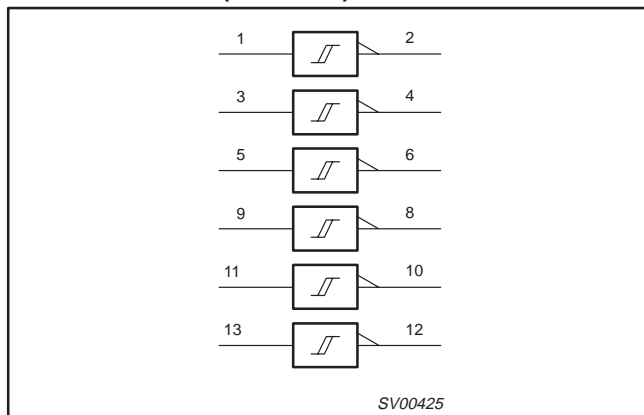
## PIN CONFIGURATION



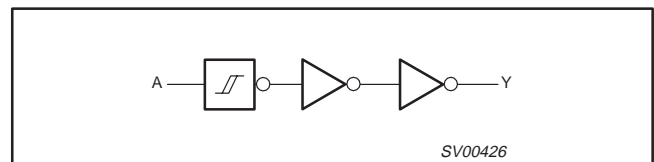
## LOGIC SYMBOL



## LOGIC SYMBOL (IEEE/IEC)



## LOGIC DIAGRAM



## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CC}$	DC supply voltage	See Note1	1.0	3.3	5.5	V
$V_I$	Input voltage		0	–	$V_{CC}$	V
$V_O$	Output voltage		0	–	$V_{CC}$	V
$T_{amb}$	Operating ambient temperature range in free air	See DC and AC characteristics	–40		+85 +125	°C

### NOTE:

- The LV is guaranteed to function down to  $V_{CC} = 1.0V$  (input levels GND or  $V_{CC}$ ); DC characteristics are guaranteed from  $V_{CC} = 1.2V$  to  $V_{CC} = 5.5V$ .

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**ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>**

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
$V_{CC}$	DC supply voltage		-0.5 to +7.0	V
$\pm I_{IK}$	DC input diode current	$V_I < -0.5$ or $V_I > V_{CC} + 0.5V$	20	mA
$\pm I_{OK}$	DC output diode current	$V_O < -0.5$ or $V_O > V_{CC} + 0.5V$	50	mA
$\pm I_O$	DC output source or sink current – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
$\pm I_{GND}$ , $\pm I_{CC}$	DC $V_{CC}$ or GND current for types with – standard outputs		50	mA
$T_{stg}$	Storage temperature range		-65 to +150	°C
$P_{TOT}$	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

**NOTES:**

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

**DC ELECTRICAL CHARACTERISTICS**

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40°C to +85°C			-40°C to +125°C		
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	
$V_{OH}$	HIGH level output voltage; all outputs	$V_{CC} = 1.2V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$		1.2				V
		$V_{CC} = 2.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	1.8	2.0		1.8		
		$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	2.5	2.7		2.5		
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	2.8	3.0		2.8		
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	4.3	4.5		4.3		
$V_{OH}$	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 6mA$	2.40	2.82		2.20		V
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 12mA$	3.60	4.20		3.50		
$V_{OL}$	LOW level output voltage; all outputs	$V_{CC} = 1.2V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0				V
		$V_{CC} = 2.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	
$V_{OL}$	LOW level output voltage; STANDARD outputs	$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 6mA$		0.25	0.40		0.50	V
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 12mA$		0.35	0.55		0.65	
$I_I$	Input leakage current	$V_{CC} = 5.5V$ ; $V_I = V_{CC}$ or GND			1.0		1.0	$\mu A$
$I_{CC}$	Quiescent supply current; SSI	$V_{CC} = 5.5V$ ; $V_I = V_{CC}$ or GND; $I_O = 0$			20.0		40	$\mu A$
$\Delta I_{CC}$	Additional quiescent supply current	$V_{CC} = 2.7V$ to $3.6V$ ; $V_I = V_{CC} - 0.6V$			500		850	$\mu A$

**NOTE:**

- All typical values are measured at  $T_{amb} = 25^\circ C$ .

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**TRANSFER CHARACTERISTICS**

Voltages are referenced to GND (ground = 0 V)

SYMBOL	PARAMETER	T <sub>amb</sub> (°C)					UNIT	TEST CONDITIONS	
		-40 TO +85			-40 TO +125			V <sub>CC</sub> (V)	WAVEFORMS
		MIN.	TYP.	MAX.	MIN.	MIN.			
V <sub>T+</sub>	Positive-going threshold	–	0.70	–	–	–	V	1.2	Figure 1 and 2
		0.8	1.10	1.4	0.8	1.4		2.0	
		1.0	1.45	2.0	1.0	2.0		2.7	
		1.2	1.60	2.2	1.2	2.2		3.0	
		1.5	1.95	2.4	1.5	2.4		3.6	
		1.7	2.50	3.15	1.7	3.15		4.5	
		2.1	3.00	3.85	2.1	3.85		5.5	
V <sub>T–</sub>	Negative-going threshold	–	0.34	–	–	–	V	1.2	Figure 1 and 2
		0.3	0.65	0.9	0.3	0.9		2.0	
		0.4	0.90	1.4	0.4	1.4		2.7	
		0.6	1.05	1.5	0.6	1.5		3.0	
		0.8	1.30	1.8	0.8	1.8		3.6	
		0.9	1.60	2.0	0.9	2.0		4.5	
		1.1	2.00	2.6	1.1	2.6		5.5	
V <sub>H</sub>	Hysteresis (V <sub>T+</sub> – V <sub>T–</sub> )	–	0.30	–	–	–	V	1.2	Figure 1 and 2
		0.2	0.55	0.8	0.2	0.8		2.0	
		0.3	0.60	1.1	0.3	1.1		2.7	
		0.4	0.65	1.2	0.4	1.2		3.0	
		0.4	0.70	1.2	0.4	1.2		3.6	
		0.4	0.80	1.4	0.4	1.4		4.5	
		0.6	1.00	1.5	0.6	1.5		5.5	

**NOTES:**

- All typical values are measured at T<sub>amb</sub> = 25°C
- The V<sub>IH</sub> and V<sub>IL</sub> from the DC family characteristics are superseded by the V<sub>T+</sub> and V<sub>T–</sub>.

**AC CHARACTERISTICS**GND = 0V; t<sub>r</sub> ≤ t<sub>f</sub> = 2.5ns; C<sub>L</sub> = 50pF; R<sub>L</sub> = 1KΩ

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS				UNIT	
				-40 to +85 °C			-40 to +125 °C		
				V <sub>CC</sub> (V)	MIN	TYP <sup>1</sup>	MAX		MIN
t <sub>PHL/PLH</sub>	Propagation delay nA to nY	Figure 6	1.2		80			ns	
			2.0		27	37			48
			2.7		20	28			35
			3.0 to 3.6		15 <sup>2</sup>	22			28
			4.5 to 5.5			18			23

**NOTES:**

- Unless otherwise stated, all typical values are measured at T<sub>amb</sub> = 25°C
- Typical values are measured at V<sub>CC</sub> = 3.3 V.

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## TRANSFER CHARACTERISTIC WAVEFORMS

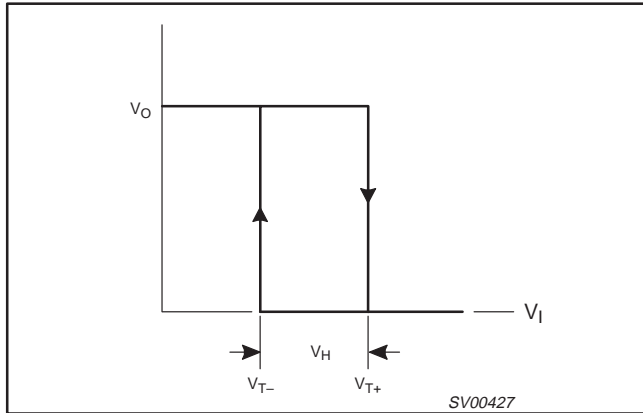


Figure 1. Transfer characteristic.

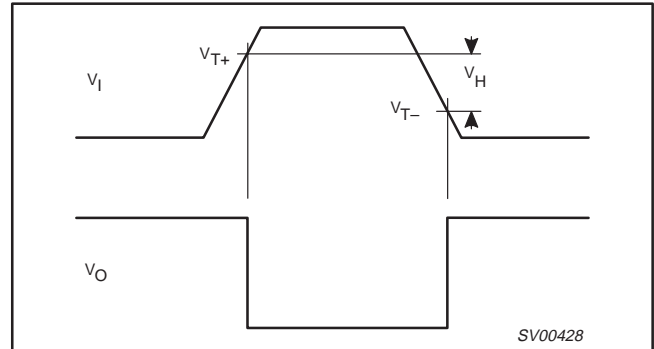


Figure 2. Definition of  $V_{T+}$ ,  $V_{T-}$  and  $V_H$ ; where  $V_{T+}$  and  $V_{T-}$  are between limits of 20% and 70%

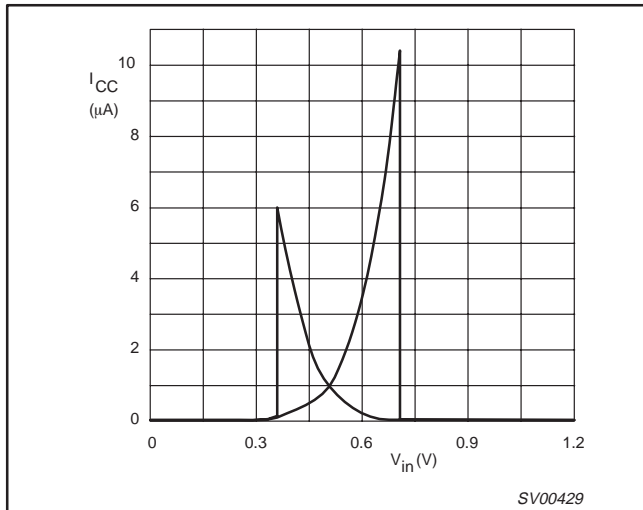


Figure 3. Typical 74LV14 transfer characteristics;  $V_{CC} = 1.2V$ .

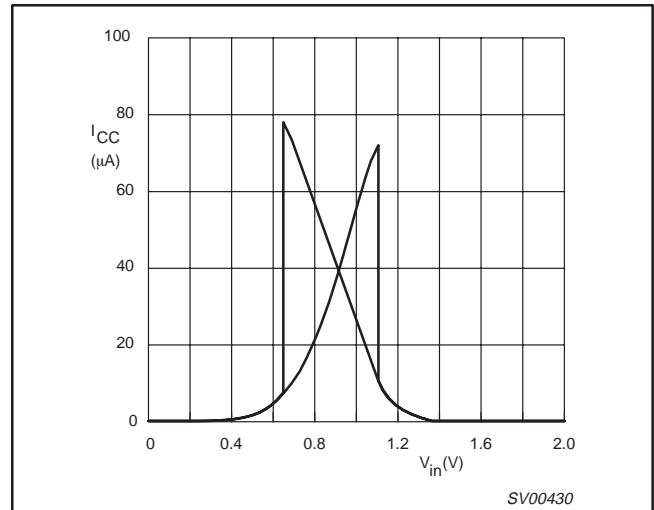


Figure 4. Typical 74LV14 transfer characteristics;  $V_{CC} = 2.0V$ .

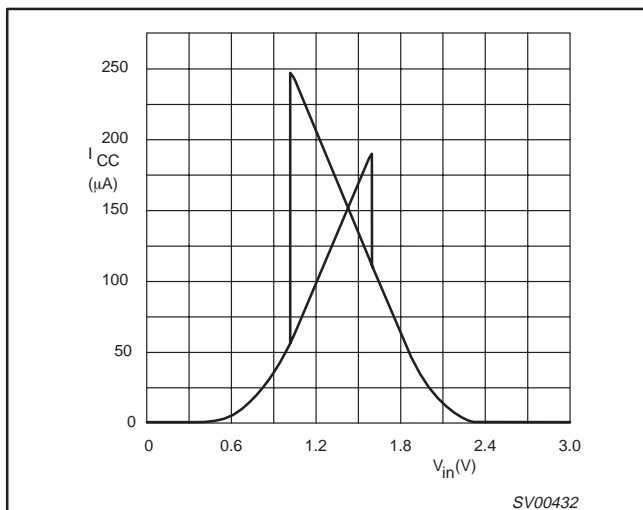


Figure 5. Typical 74LV14 transfer characteristics;  $V_{CC} = 3.0V$ .

## AC WAVEFORMS

$V_M = 1.5 V$  at  $V_{CC} \geq 2.7 V$ ;

$V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7 V$

$V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.

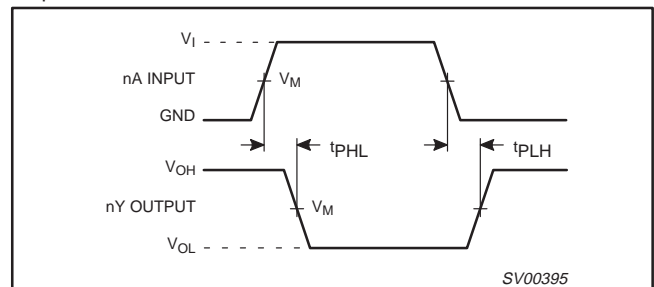


Figure 6. Input (nA) to output (nY) propagation delays.

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## APPLICATION INFORMATION

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

$$P_{ad} = f_i \times (t_r \times I_{CCa} + t_f \times I_{CCa}) \times V_{CC}$$

**Where:**

$P_{ad}$  = additional power dissipation ( $\mu W$ )

$f_i$  = input frequency (MHz)

$t_r$  = input rise time (ns); 10% – 90%

$t_f$  = input fall time (ns); 10% – 90%

$I_{CCa}$  = average additional supply current ( $\mu A$ )

Average  $I_{CCa}$  differs with positive or negative input transitions, as shown in Figure 7.

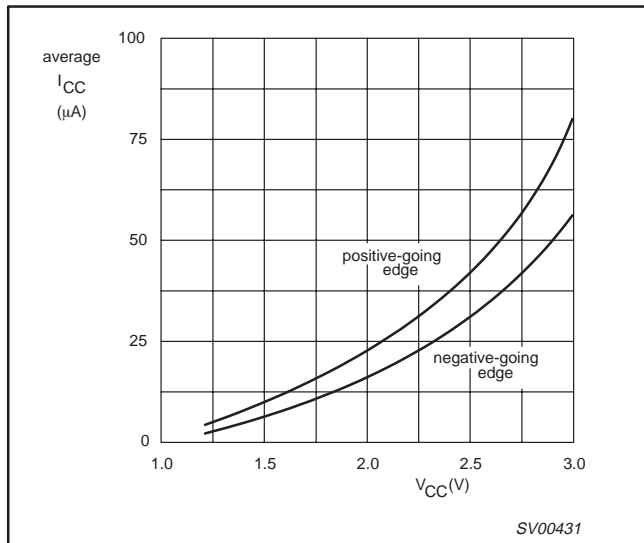


Figure 7. Average  $I_{CC}$  for LV Schmitt-trigger devices; linear change of  $V_I$  between  $0.1 V_{CC}$  to  $0.9 V_{CC}$ .

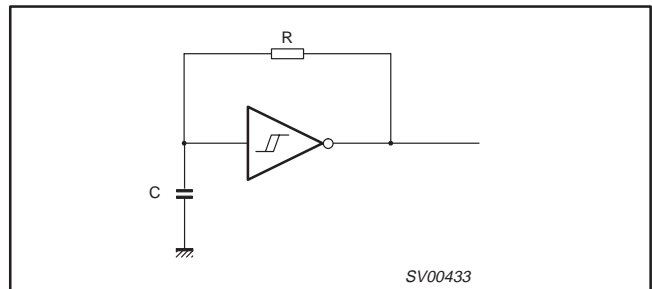


Figure 8. Relaxation oscillator using the LV14.

**Note to application information:**

All values given are typical unless otherwise specified.

Note to Figure 8

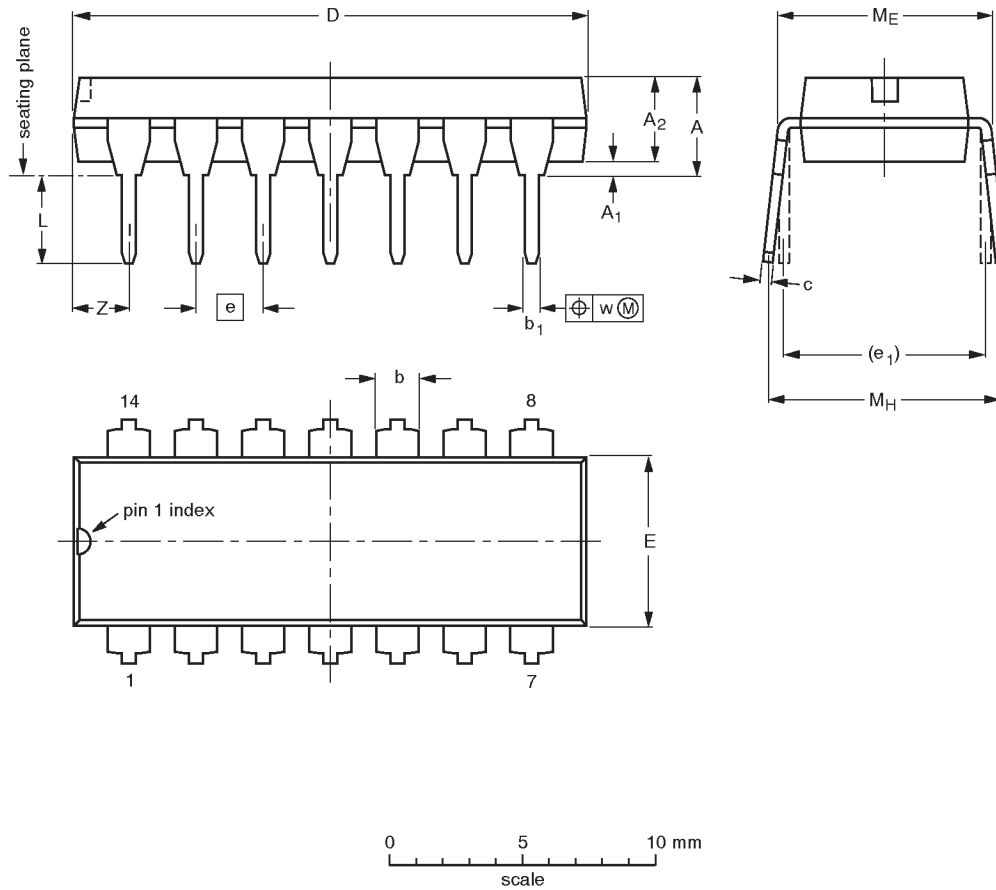
$$f = \frac{1}{T} \approx \frac{1}{0.8 \times RC}$$

# Hex inverting Schmitt-trigger

## 74LV14

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT27-1	050G04	MO-001AA			92-11-17 95-03-11

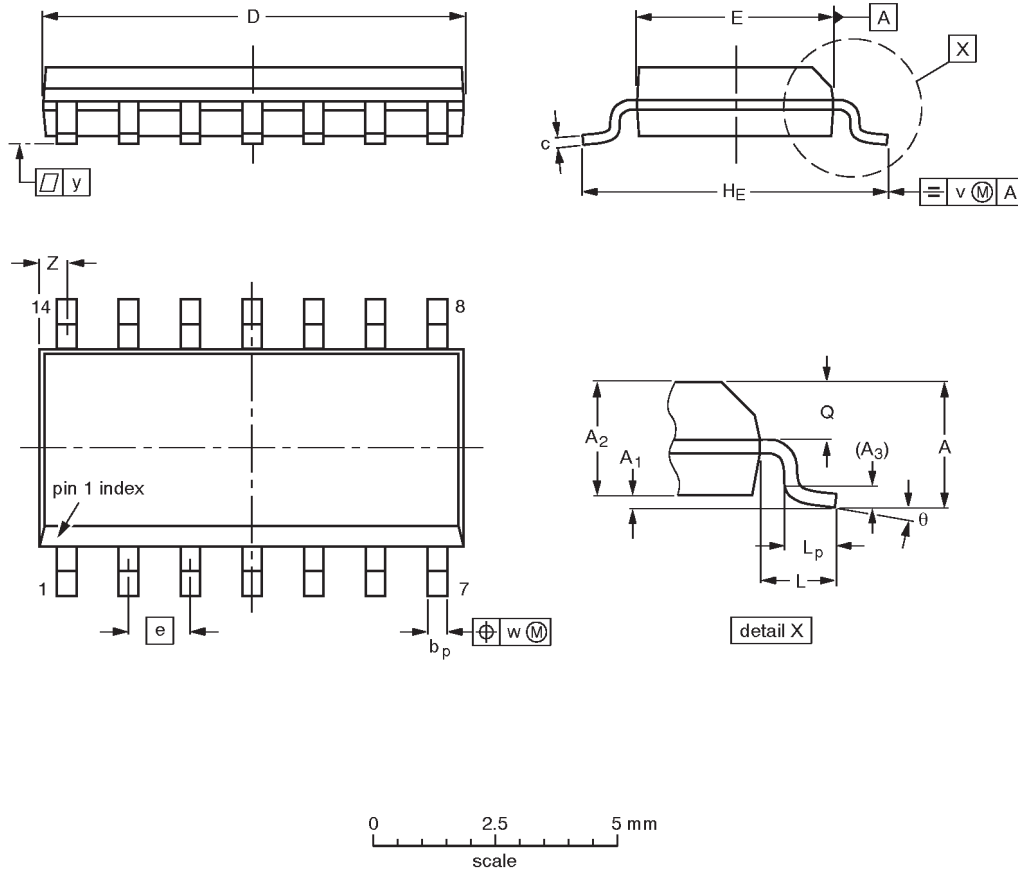


# Hex inverting Schmitt-trigger

## 74LV14

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.35 0.34	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

**Note**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

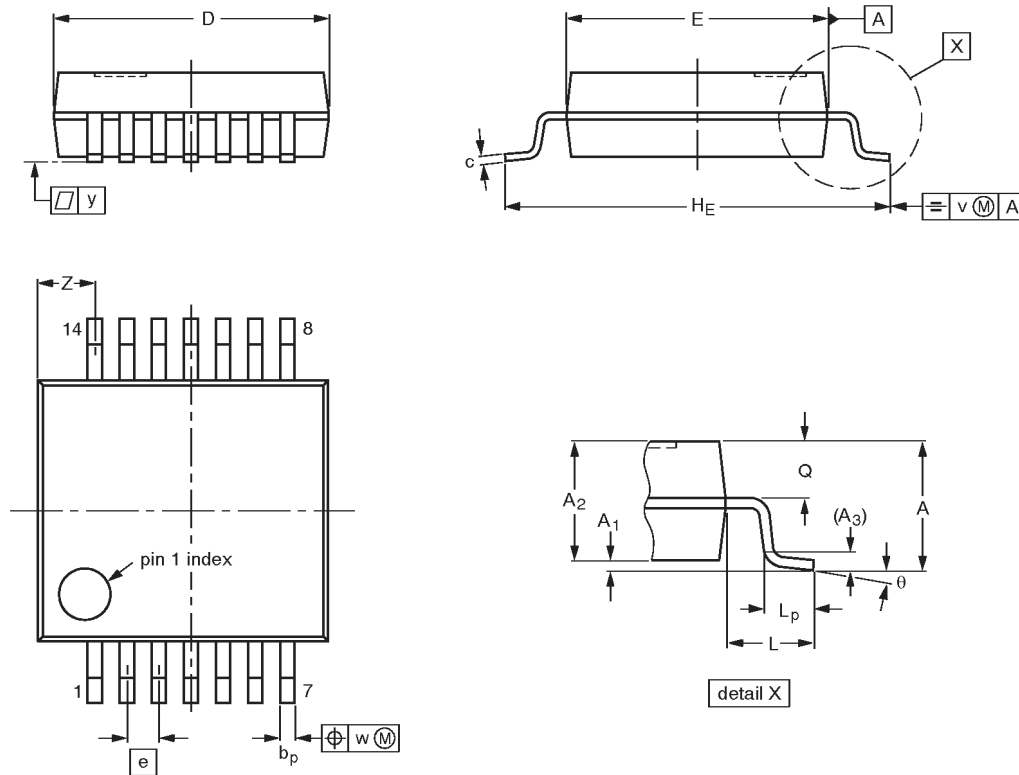
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06S	MS-012AB				91-08-13 95-01-23

# Hex inverting Schmitt-trigger

# 74LV14

**SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm**

**SOT337-1**



**DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

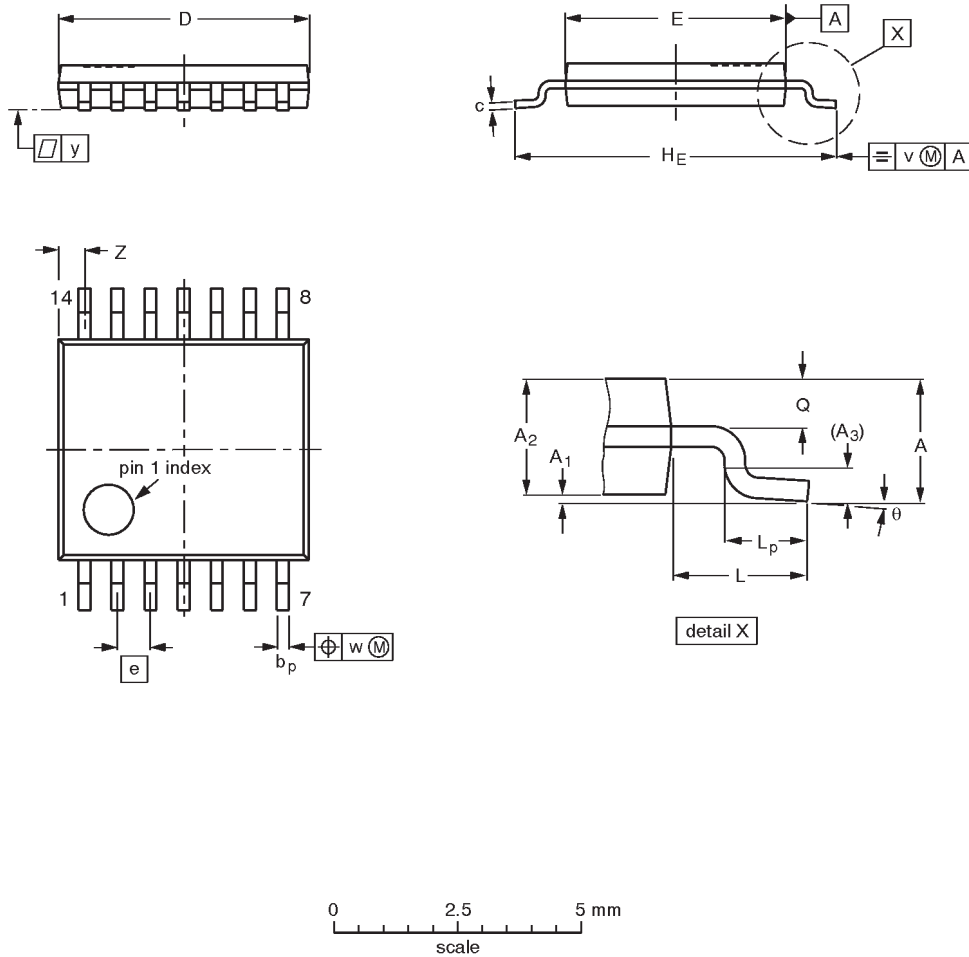
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT337-1		MO-150AB				<del>95-02-04</del> 96-01-18

# Hex inverting Schmitt-trigger

## 74LV14

**TSSOP14:** plastic thin shrink small outline package; 14 leads; body width 4.4 mm

**SOT402-1**



**DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

**Notes**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT402-1		MO-153				-94-07-12- 95-04-04

## Hex inverting Schmitt-trigger

74LV14

## DEFINITIONS

Data Sheet Identification	Product Status	Definition
<i>Objective Specification</i>	<b>Formative or in Design</b>	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
<i>Preliminary Specification</i>	<b>Preproduction Product</b>	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
<i>Product Specification</i>	<b>Full Production</b>	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.

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